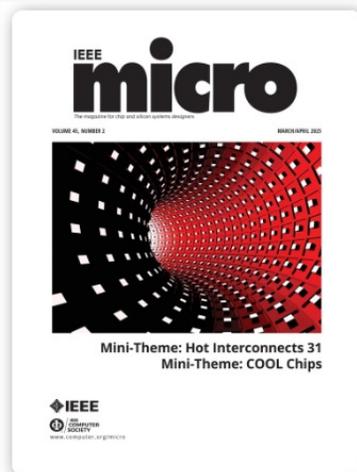SPONSORSHIP PLANS 2026

Hot Interconnects

IEEE Hot Interconnects is the **premier international forum** for researchers and developers of state-of-the-art hardware and software architectures and implementations for **interconnection networks** of all scales.

Industry and academic leaders participate in the conference to engage with experts who are leading advancements in this area.

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Keywords

https://hoti.org/

HotI Publications

Peer-reviewed publications:

- Two paper formats supported:
  - **Hot topic** short papers (3-4 pages)
  - **Full length** papers (10 pages)
- HOTI papers published to **IEEE Xplore** (HOTI proceedings)
- A **best paper** award in **industry** and **academia** categories
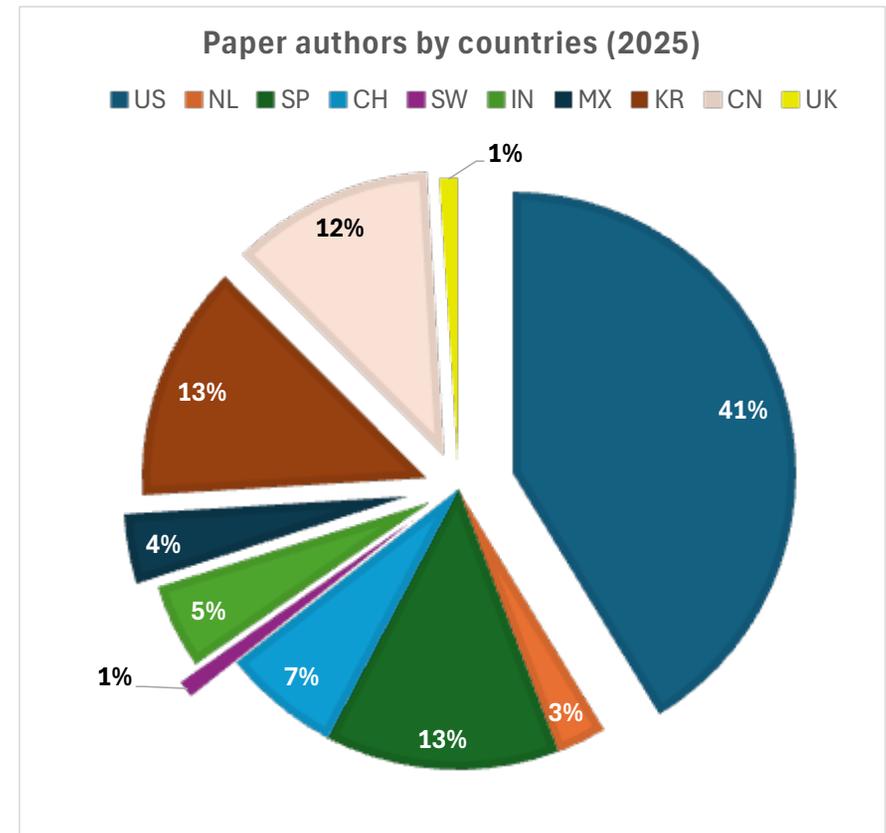- Selected papers published in **IEEE Micro** (2024 edition here)
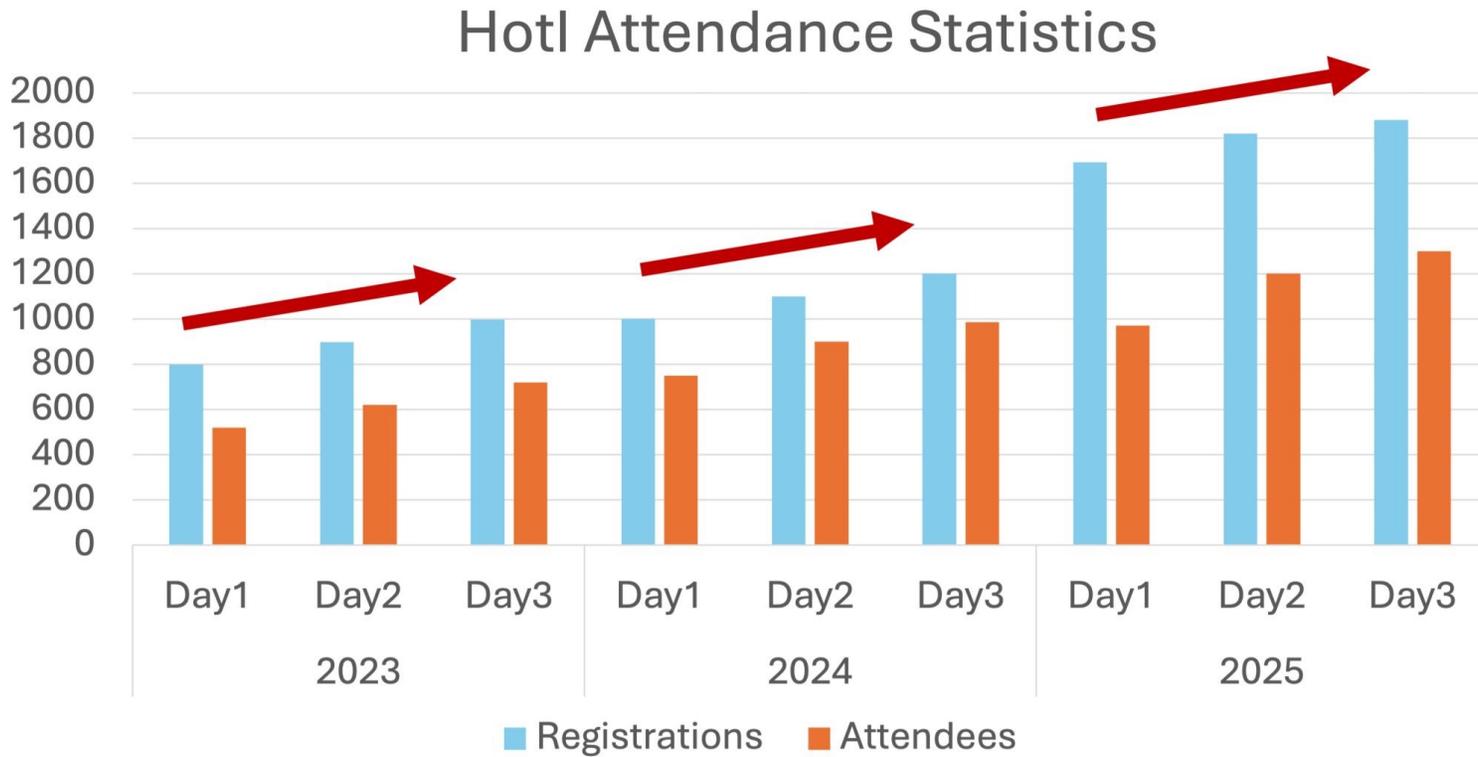

Statistics and Rankings:

- **LiveSHINE** and **Microsoft Academic** give HOTI an **A ranking w/ 19-20 average citations per paper**.
- **DBLP** reports an average of **36 citations per paper** (see live DBLP database query here).
- **ICORE** ranks with approximately a **B citation ranking** (ICORE HOTI, CORE2023 citations).
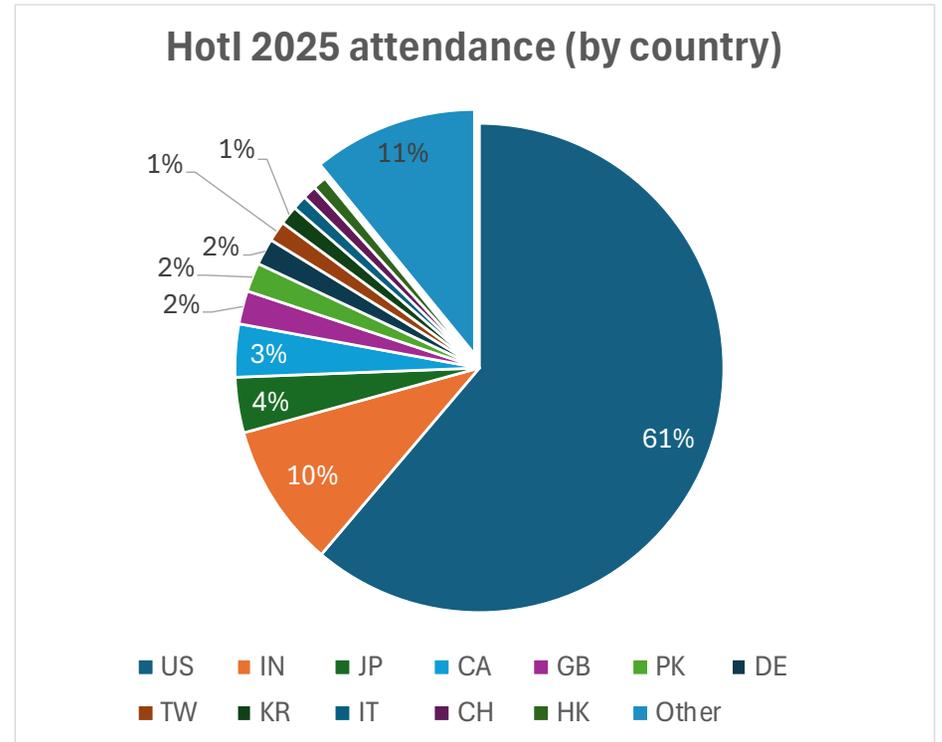
HOTI 2025 Technical Content

- Hotl'25 **Technical Program Committee** (TPC)
  - **31 members**
  - From
    - **19 organizations** (37% Academia, 63% Industry)
    - France, Japan, South Korea, Spain, Switzerland, and US
- **Peer review process**
  - 4 reviews/paper
  - 9 Papers accepted
    - 8 full papers
    - 1 short hot-topic paper
  - Overall acceptance rate of 39%
- **Dedicated tutorials day**
  - Hands-on sessions from industry experts!

Paper authors by countries (2025)

Legend: US, NL, SP, CH, SW, IN, MX, KR, CN, UK

US 41%, CN 12%, UK 1%, KR 13%, MX 4%, IN 5%, SW 1%, CH 7%, SP 13%, NL 3%

HOTI 2023-2025 attendance

HOTI 2024/2025 attendance world-wide

HotI 2024 Attendance

US 66%
JP 6%
CA 6%
UK 3%
CN 3%
IN 2%
Other 5%

Legend: US, JP, CA, UK, CN, IN, KR, IL, DE, NL, TW, BE, BR, FR, CH, Other

HotI 2025 attendance (by country)

61%
11%
10%
4%
3%
2%
2%
2%
1%
1%

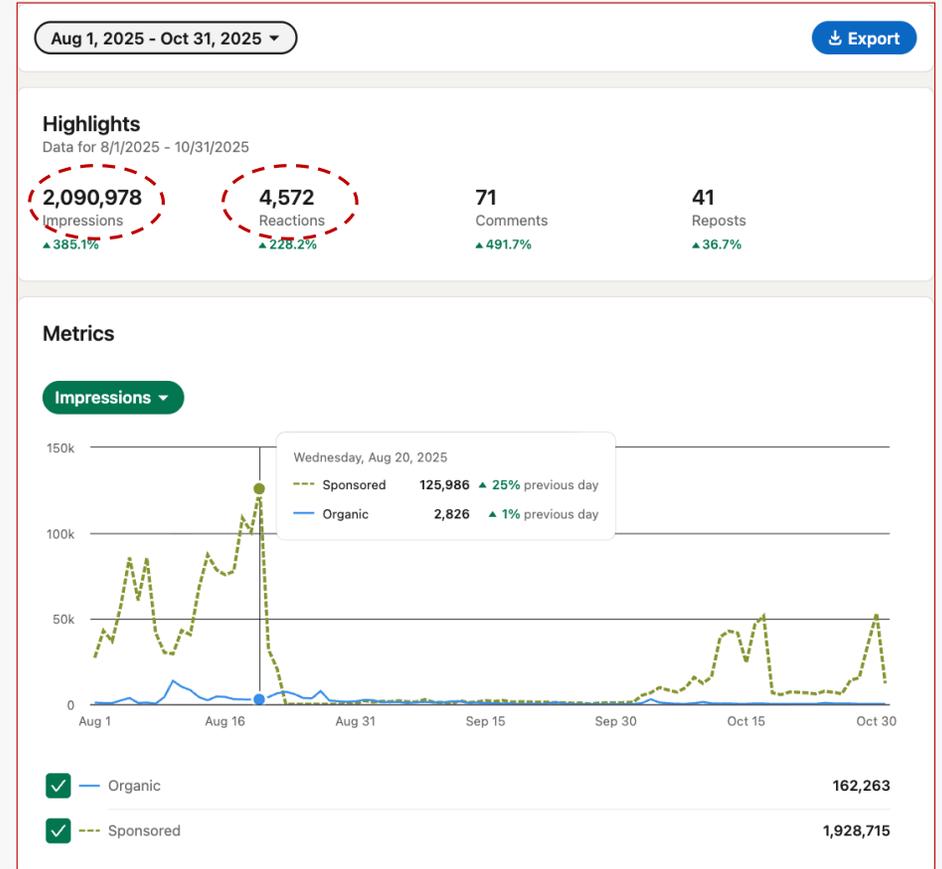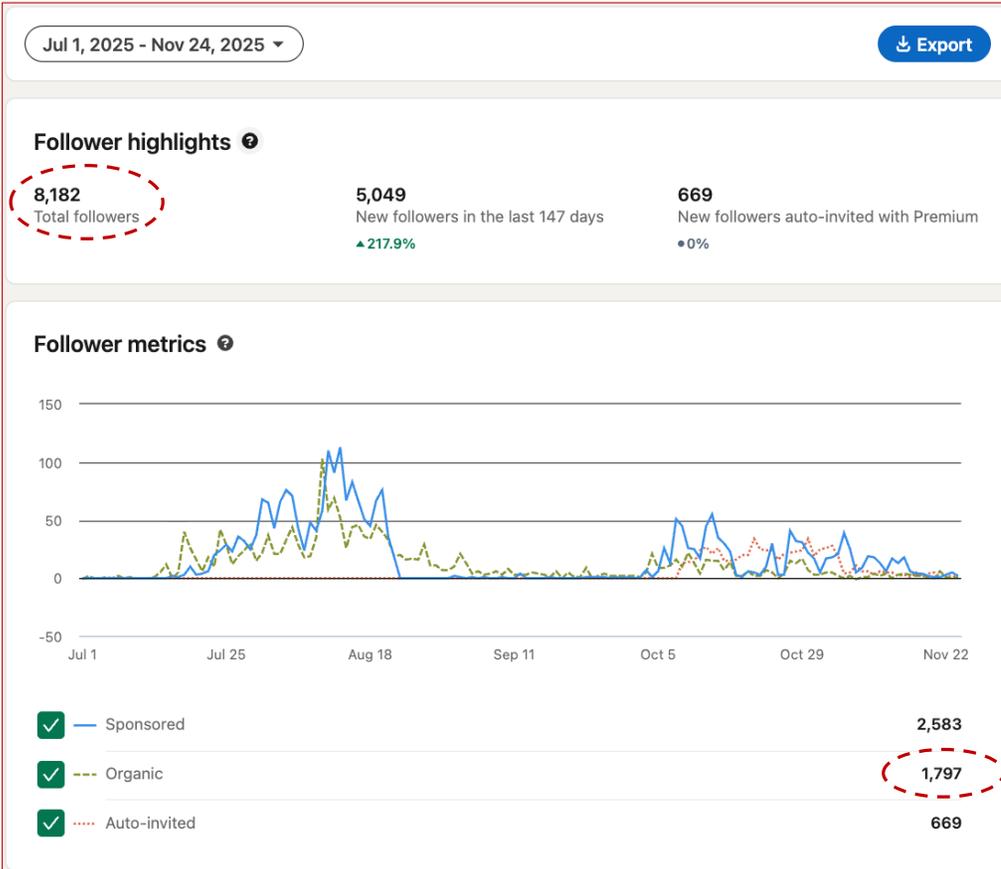Legend: US, IN, JP, CA, GB, PK, DE, TW, KR, IT, CH, HK, Other
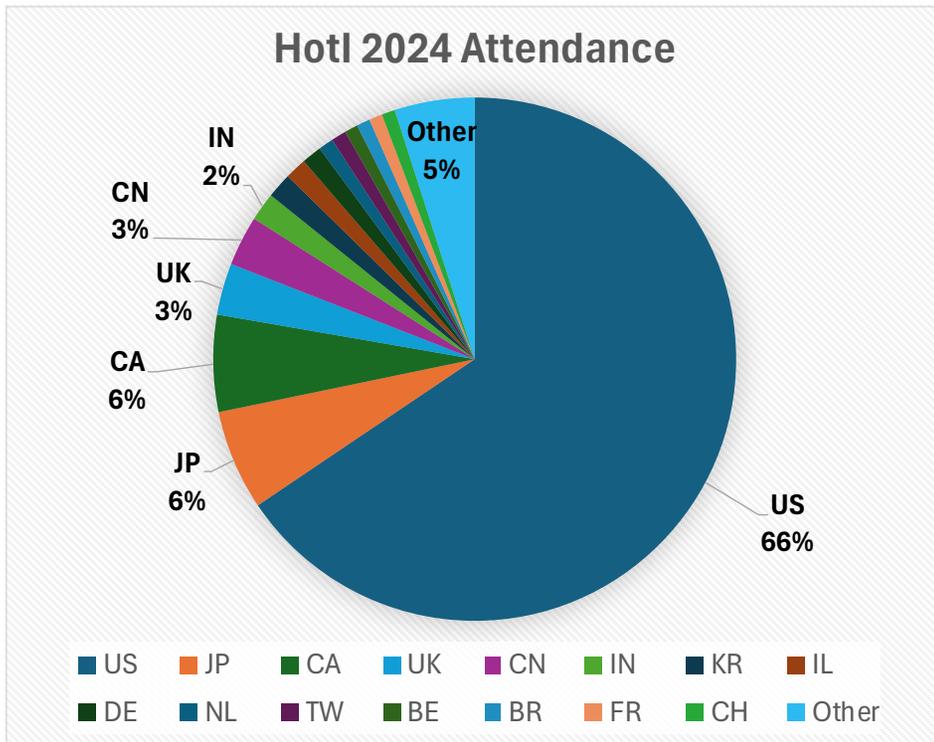
62 countries total!

Active LinkedIn presence

Organic growth (**8K+ followers**), active community (**thousands** of reactions, **millions** of impressions)

In-demand content (YouTube)

All HotI talks are **recorded and published** on YouTube

2024

Your channel has gotten 37,832 views so far

Views 37.8K — Watch time (hours) 5.4K — Subscribers +917

2025

Views 74.1K — Watch time (hours) 9.3K — Subscribers +1.7K

Ever-increasing spike around the event

Steadily growing interest "tail"
That persist throughout the year
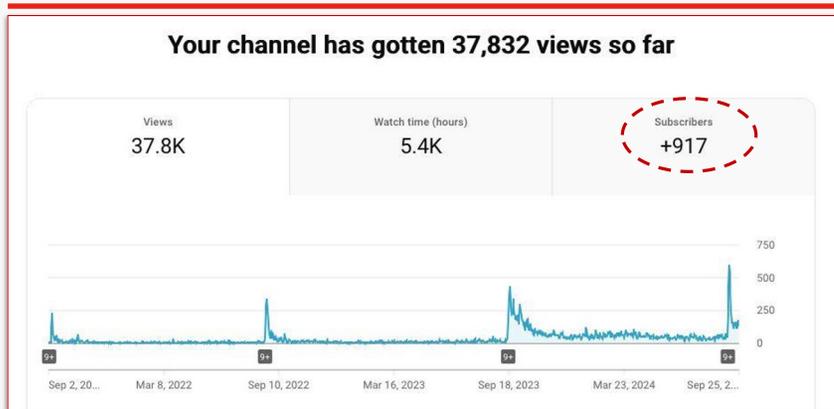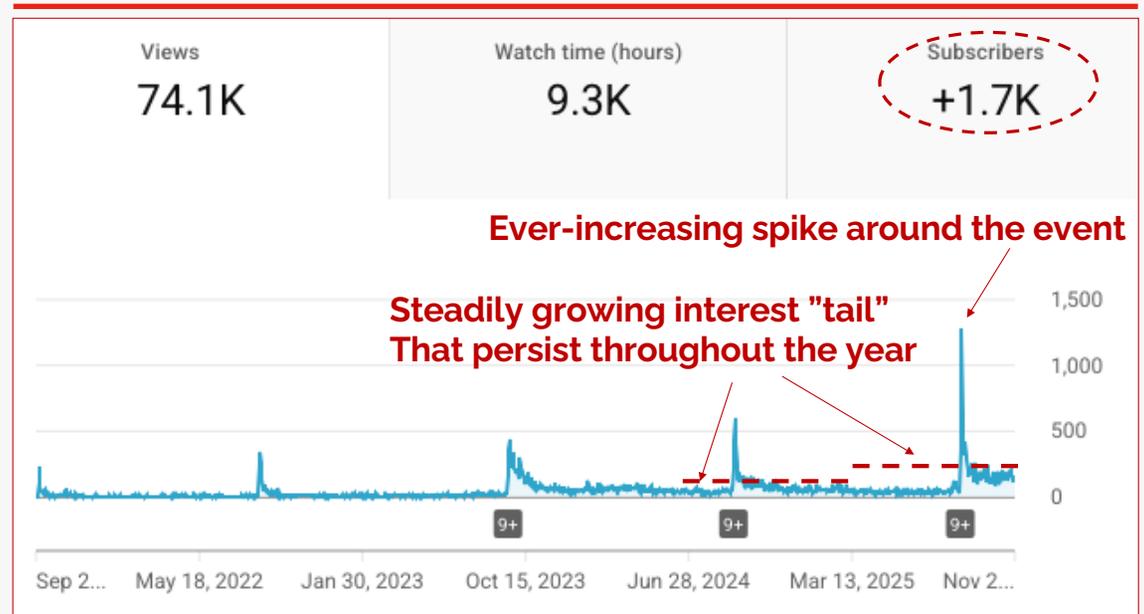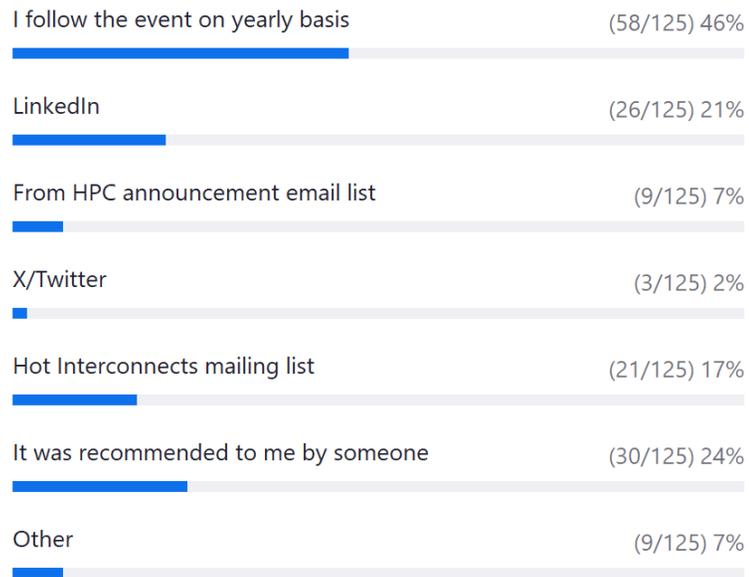
Audience engagement

How did you hear about Hot-I?

Poll ended | 1 question | 125 total responses (i)

1. How did you learn about HotI this year?
(Multiple choice)
125/125 (100%) answered

I follow the event on yearly basis	(58/125) 46%
LinkedIn	(26/125) 21%
From HPC announcement email list	(9/125) 7%
X/Twitter	(3/125) 2%
Hot Interconnects mailing list	(21/125) 17%
It was recommended to me by someone	(30/125) 24%
Other	(9/125) 7%

Returning attendees

High impact from social media strategies

Leveraging community channels

Established communication

High impact of "**word of mouth**"

Increasing sponsorship interest

HotI 2025 in the News!

- Nvidia opens NVLink fabric to hyperscaler custom silicon,
  sxdCentral: https://www.sdxcentral.com/news/nvidia-opens-nvlink-fabric-to-hyperscaler-custom-silicon/
- Google Is Already Using The Future AI Network You Might Get In 2028
  The Next Platform: https://www.nextplatform.com/2025/08/21/google-is-already-using-the-future-ai-network-you-might-get-in-2028/
- Hot Interconnects: Arista Outlines Pathways to Energy-Efficient Optics and Liquid-Cooled Racks
  Converge Digest: https://convergedigest.com/hoti25-arista-outlines-pathways-to-energy-efficient-optics-and-liquid-cooled-racks/?amp=1
- Evolving Interconnect Fabric and SDN in the Cloud to Meet the Needs of AI
  Segment Routing: https://www.segment-routing.net/conferences/2025-08-20-hoti-symposium-2025/
- Hot Interconnects: Meta Highlights 600K GPUs, Custom Chips, Next-Gen Fabrics
  Converge Digest: https://convergedigest.com/hoti25-meta-highlights-600k-gpus-custom-chips-next-gen-fabrics/?amp=1
- Hot Interconnects: Microsoft Maps Out $100B AI Networking Fabric
  Converge Digest: https://convergedigest.com/hoti25-microsoft-maps-out-100b-ai-networking-fabric/?amp=1
- HOTI25: Lightmatter's Roadmap to 100x AI Bandwidth
  Converge Digest: https://convergedigest.com/hot-interconnects-lightmatters-roadmap-to-100x-ai-bandwidth/
- Nvidia opens NVLink fabric to hyperscaler custom silicon
  Data Center Dynamics (DCD): https://www.datacenterdynamics.com/en/news/nvidia-opens-nvlink-fabric-to-hyperscaler-custom-silicon/
- What's Up with HPC Interconnects? A Q&A with HotI
  HPCwire: https://www.hpcwire.com/2025/10/07/whats-up-with-hpc-interconnects-a-qa-with-hoti/

2026 Conference Theme

Scale-Up, Scale-Out, Scale-Across: Do they really differ?

Complex high-capacity training and disaggregated inference workloads are being scaled-across multiple sites, blurring the lines between contemporary scale-out and scale-up interconnection stacks. All the classical issues such as jitter, bursts, flow/congestion, long-tail latencies, etc. are amplified over long distances, requiring deliberate interventions across the full interconnection stack: algorithms, operational tools, communication frameworks, and network fabrics. This edition of Hot Interconnects will explore these interventions behind operationalizing interconnects over long, short and shorter distances.

SPONSORSHIP LEVELS 2026

For levels with limited sponsorship slots, allocation is **first-come, first-served**.

| Level	# of slots	Cost	Speaking Slot Time	Sponsor Logo Size (website/event)	Email Distribution (59K recipients)	Recording	Social media
Diamond	**3**	$5000	**15 min**		✅	✅	More prominent
Platinum	**5**	$3500	**10 min**		✅	✅	⌄⌄
Gold	Unlimited	$2000	N/A		✅	✅	⌄⌄
Silver	Unlimited	$1000	N/A		✅	✅	Less prominent

HOW TO BECOME A SPONSOR

Becoming a sponsor:

- **Step 1**. Select a sponsorship level
- **Step 2**. Send an email to: sponsor@hoti.org
- **Step 3**. Make sponsor payment

Benefits:

- A **dedicated presentation slot** (recording or live) during the conference with a targeted audience interested in network interconnect technologies
- **Sponsor logos** displayed during conference (in breaks)
- Logo displayed on the website throughout 2026 (starting from the time of becoming a sponsor)
- **Advertisements** on official **Hot Interconnects** social media channels (LinkedIn, X/Twitter and Facebook)
- **Attendance statistics** provided after the event per request.
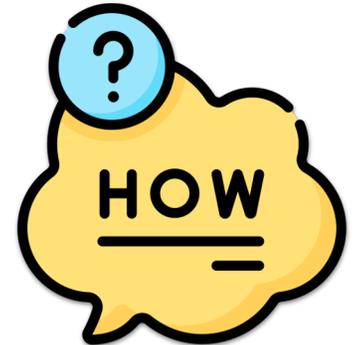
Thank you!

Questions? sponsor@hoti.org